

**Amendments to the Claims:**

This listing of claims will replace all prior versions and listings of claims in the application.

**Listing of Claims:**

1. (currently amended) An electronic circuit device, comprising:  
    ~~internal terminals;~~  
    a board on which internal terminals and wirings connected to the internal terminals are formed;  
    an electronic component that is mounted on the board and is connected with the internal terminals; and  
    an encapsulation resin with which the electronic component and the internal terminals are encapsulated,  
    wherein a part of the wiring forms a ring-shaped portion, the ring-shaped portion having a plurality of gaps by which the ring-shaped portion is divided into a plurality of discontinuous ring-constituting sections, and  
    wherein the plurality of ring-constituting sections are connected to the respective internal terminals, and a coating region of the encapsulation resin is in contact with an inner side of ~~is surrounded with~~ the ring-shaped portion.
2. (original) The electronic circuit device according to claim 1, wherein the ring-shaped portions of the wirings are formed as a multi-ring.
3. (original) The electronic circuit device according to claim 1,  
    wherein the internal terminals are disposed within the ring-shaped portion,  
    the wirings extend from an outside of the ring-shaped portion to the respective internal terminals so as to be connected thereto via the ring-shaped portion, and  
    a connecting point of the wiring extending from the internal terminal with the ring-shaped portion and a connecting point of the wiring extending from the outside with the ring-shaped portion are disposed at positions different from each other.

4. (original) The electronic circuit device according to claim 1, wherein an intersecting portion of the ring-shaped portion and one end of the wiring is shaped like a letter T.
5. (original) The electronic circuit device according to claim 2, wherein the gaps provided in the respective wirings of the multi-ring as the ring-shaped portion are disposed so as not to be on a same normal line with respect to the ring-shaped portion.
6. (original) The electronic circuit device according to claim 1, wherein the wiring is connected with a wiring on a rear face of the board via a through hole formed in the board, the through hole being disposed adjacent to an outer edge of the ring-shaped portion.
7. (original) The electronic circuit device according to claim 1, wherein the wiring is connected with a wiring on a rear face of the board via a through hole formed in the board, the through hole being disposed within the ring-shaped portion.
8. (original) The electronic circuit device according to of claim 1, wherein a part of the wiring is formed so as to divide an inner region of the ring-shaped portion into a region including the internal terminals and a region not including the internal terminals.
9. (original) The electronic circuit device according to claim 1, wherein three or more wirings are formed, and at an intersecting portion of the wirings and the ring-shaped portion, two or less line segments are disposed linearly and in parallel from an outside to an inside of the ring-shaped portion.
10. (original) The electronic circuit device according to claim 1, wherein the wiring extending on the outside of the ring-shaped portion and the ring-shaped portion of the wiring intersect each other at angles of 60° or more.